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Kind regards,

Team Nexperia

Product data sheet

## 1. Product profile

### 1.1 General description

Planar Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

### 1.2 Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

### 1.3 Applications

- Ultra high-speed switching
- Line termination

- Voltage clamping
- Reverse polarity protection

### 1.4 Quick reference data

Table 1. Quick reference data

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{R}$	reverse voltage		-	-	40	V
V <sub>F</sub>	forward voltage	$I_F = 500 \text{ mA}$	<u>[1]</u> _	-	550	mV
I <sub>R</sub>	reverse current	$V_{R} = 35 \text{ V}$	<u>[1]</u> _	-	100	μΑ

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

## 2. Pinning information

Table 2. Pinning

	3			
Pin	Description	Simplified outline	Graphic symbol	
1	anode			
2	not connected		3	
3	cathode	1 2	1 2 n.c. 006aaa436	



### Schottky barrier diode

# 3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAT720	-	plastic surface-mounted package; 3 leads	SOT23

## 4. Marking

Table 4. Marking codes

Type number	Marking code[1]
BAT720	L6*

<sup>[1] \* =</sup> placeholder for manufacturing site code.

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage		-	40	V
I <sub>F</sub>	forward current		-	500	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave; t <sub>p</sub> < 10 ms	<u>[1]</u> -	2	Α
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	[2] -	200	mW
T <sub>j</sub>	junction temperature		-	125	°C
T <sub>amb</sub>	ambient temperature		<b>–55</b>	+125	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup>  $T_i = 25$  °C before surge.

### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	500	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[2]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

### Schottky barrier diode

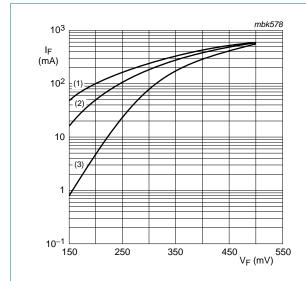
### 7. Characteristics

Table 7. Characteristics

 $T_i = 25$  °C unless otherwise specified.

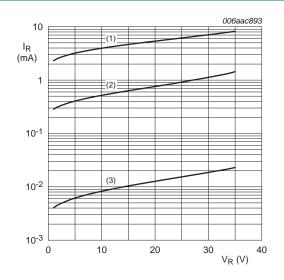
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	$I_F = 500 \text{ mA}$	<u>[1]</u> _	-	550	mV
I <sub>R</sub>	reverse current	$V_{R} = 35 \text{ V}$	<u>[1]</u> _	-	100	μΑ
		$V_R = 35 \text{ V}; T_j = 100 ^{\circ}\text{C}$	<u>[1]</u> _	-	10	mA
C <sub>d</sub>	diode capacitance	$f = 1 MHz; V_R = 0 V$	60	-	90	pF

[1] Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 



- (1) T<sub>amb</sub> = 125 °C
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

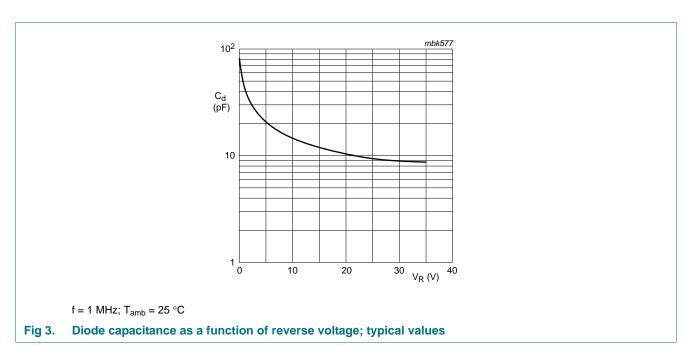
Fig 1. Forward current as a function of forward voltage; typical values



- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values

### Schottky barrier diode



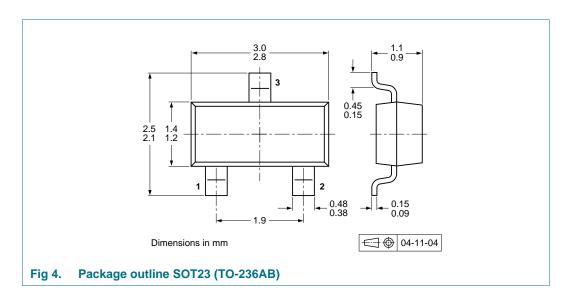
### 8. Test information

## 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

Schottky barrier diode

## 9. Package outline



# 10. Packing information

Table 8. Packing methods

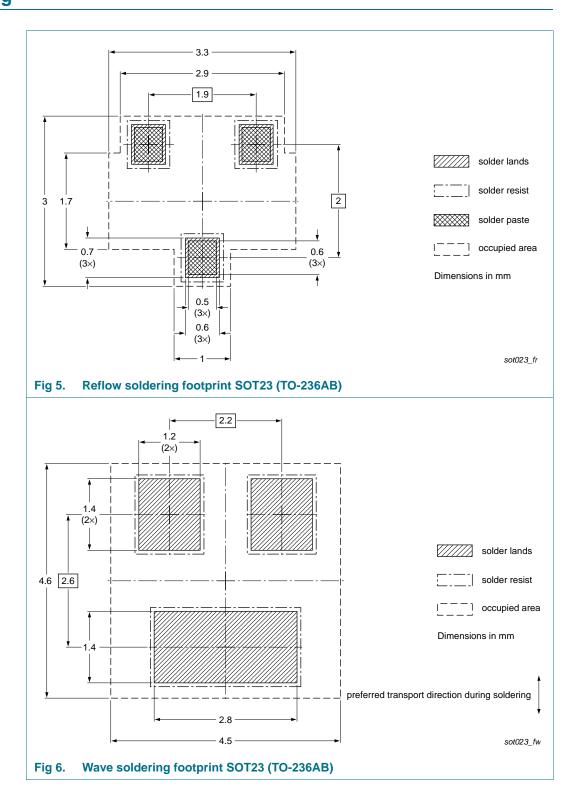
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
BAT720	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

### Schottky barrier diode

## 11. Soldering



## Schottky barrier diode

# 12. Revision history

### Table 9. Revision history

Release date	Data sheet status	Change notice	Supersedes		
20121114	Product data sheet	-	BAT720 v.3		
		redesigned to comply w	ith the new identity		
<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
Section 1: updated					
Section 4: updated					
<ul> <li><u>Table 5</u>: added ambient temperature T<sub>amb</sub> and total power dissipation P<sub>tot</sub></li> </ul>					
• Figure 2: updated					
Section 8 "Test information": added					
<ul> <li>Figure 4: replaced by minimized package outline drawing</li> </ul>					
<ul> <li>Section 10 "Packing information": added</li> </ul>					
Section 11 "Soldering": added					
Section 13	"Legal information": updated	t l			
20030325	Product data sheet	-	BAT720 v.2		
19990526	Product specification	-	BAT720 v.1		
	20121114  The format guidelines of Legal texts Section 1: 0 Section 4: 0 Table 5: add Figure 2: up Section 8 " Figure 4: re Section 10 Section 11 Section 13	Product data sheet  The format of this document has been a guidelines of NXP Semiconductors.  Legal texts have been adapted to the new Section 1: updated  Section 4: updated  Table 5: added ambient temperature Table 5: added ambient temperature Table 5: added ambient temperature Table 5: updated  Section 8 "Test information": added  Figure 4: replaced by minimized package Section 10 "Packing information": added  Section 11 "Soldering": added  Section 13 "Legal information": updated	The format of this document has been redesigned to comply we guidelines of NXP Semiconductors.  Legal texts have been adapted to the new company name where Section 1: updated  Section 4: updated  Table 5: added ambient temperature Tamb and total power disses Figure 2: updated  Section 8 "Test information": added  Figure 4: replaced by minimized package outline drawing  Section 10 "Packing information": added  Section 11 "Soldering": added  Section 13 "Legal information": updated		

Schottky barrier diode

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BAT720

### Schottky barrier diode

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For sales office addresses, please send an email to: salesaddresses@nxp.com

**BAT720 NXP Semiconductors** 

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